



MDS35 / 50 / 80 Series

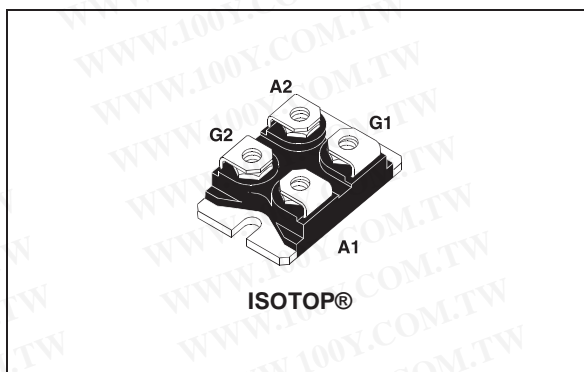
DIODE / SCR MODULE

MAIN FEATURES:

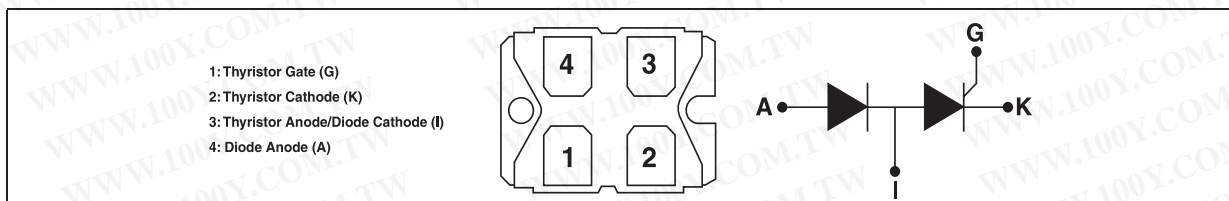
Symbol	Value	Unit
$I_{T(RMS)}$	50-70-85	A
V_{DRM}/V_{RRM}	800 and 1200	V
I_{GT}	50 and 100	mA

DESCRIPTION

Packaged in ISOTOP modules, the MDS Series is based on the half-bridge SCR-diode configuration. They are suitable for high power applications, using phase controlled bridges, such as soft-start circuits, welding equipment, motor speed controller. The compactness of the ISOTOP package allows high power density and optimized power bus connections. Thanks to their internal ceramic pad, they provide high voltage insulation (2500V RMS), complying with UL standards (File ref: E81734).



PIN CONNECTIONS



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value			Unit			
		35	50	80				
$I_{T(RMS)}$	RMS on-state current	50	70	85	A			
$I_{T(AV)}$	Average on-state current (Single phase-circuit, 180° conduction angle per device)	$T_c = 85^\circ\text{C}$		25	35	55	A	
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$t_p = 8.3$ ms	$T_j = 25^\circ\text{C}$		420	630	730	A
I_{FSM}			$t_p = 10$ ms	$T_j = 25^\circ\text{C}$		400	600	700
I_t^2	I_t^2 Value for fusing	$t_p = 10$ ms	$T_j = 25^\circ\text{C}$		800	1800	2450	A ² s
di/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100$ ns	F = 60 Hz	$T_j = 125^\circ\text{C}$		50		A/ μ s	
I_{GM}	Peak gate current	$t_p = 20$ μ s	$T_j = 125^\circ\text{C}$		4		A	
$P_{G(AV)}$	Average gate power dissipation	$T_j = 125^\circ\text{C}$		1		W		
T_{stg}	Storage junction temperature range			- 40 to + 150		°C		
T_j	Operating junction temperature range			- 40 to + 125				
V_{RGM}	Maximum peak reverse SCR gate voltage			5		V		

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ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise specified)

SCR

Symbol	Test Conditions			MDS			Unit	
				35	50	80		
I _{GT}	V _D = 12 V	R _L = 30 Ω	MIN.	5	10	mA		
			MAX.	50	100			
V _{GT}			MAX.	1.3			V	
V _{GD}	V _D = V _{DRM}	R _L = 3.3 kΩ	T _j = 125°C	MIN.	0.2			V
I _H	I _T = 500 mA	Gate open		MAX.	80			mA
I _L	I _G = 1.2 I _{GT}			MAX.	120			mA
dV/dt	V _D = 67% V _{DRM}	Gate open	T _j = 125°C	MIN.	1000			V/μs
V _{TM}	I _{TM} = 80 A	tp = 380 μs	T _j = 25°C	MAX.	1.7	-	-	V
	I _{TM} = 110 A	tp = 380 μs			-	1.75	-	
	I _{TM} = 170 A	tp = 380 μs			-	-	1.75	
V _{t0}	Threshold voltage		T _j = 125°C	MAX.	0.85			V
R _d	Dynamic resistance		T _j = 125°C	MAX.	11	7.0	5.5	mΩ
I _{DRM} I _R	V _{DRM} / V _R RATED		T _j = 25°C	MAX.	20			μA
			T _j = 125°C		10			mA

DIODE

Symbol	Test Conditions			MDS			Unit	
				35	50	80		
V _F	I _F = 80 A	T _j = 25°C	MAX.	1.7	-	-	V	
	I _F = 110 A			-	1.7	-		
	I _F = 170 A			-	-	1.7		
V _{t0}	Threshold voltage		T _j = 125°C	MAX.	0.85			V
R _d	Dynamic resistance		T _j = 125°C	MAX.	11	7.0	5.5	mΩ
I _R	V _R = V _R RATED		T _j = 25°C	MAX.	20			μA
			T _j = 125°C		10			mA

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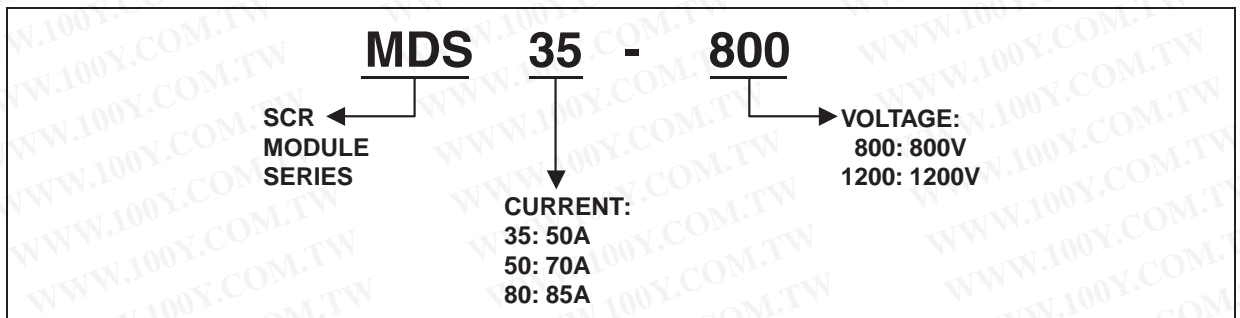
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case (DC)	MDS35	1.00
		MDS50	0.75
		MDS80	0.45

PRODUCT SELECTOR

Part Number	Voltage (xxx)		Sensitivity	Package
	800 V	1200 V		
MDS35-xxx	X	X	50 mA	ISOTOP™
MDS50-xxx	X	X	50 mA	
MDS80-xxx	X	X	150 mA	

ORDERING INFORMATION



OTHER INFORMATION

Part Number	Marking	Weight	Base Quantity	Packing mode
MDS35-xxx	MDS35-xxx	27.0 g	10	Tube
MDS50-xxx	MDS50-xxx	27.0 g	10	Tube
MDS80-xxx	MDS80-xxx	27.0 g	10	Tube

Note: xxx = voltage

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Fig. 1-1: Maximum average power dissipation versus average on-state current (thyristor or diode, sinusoidal waveform).

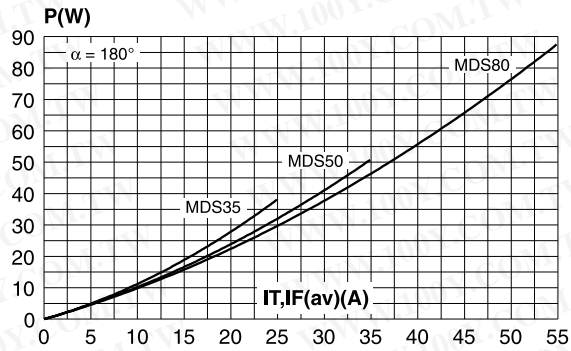


Fig. 1-2: Maximum average power dissipation versus average on-state current (thyristor or diode, rectangular waveform).

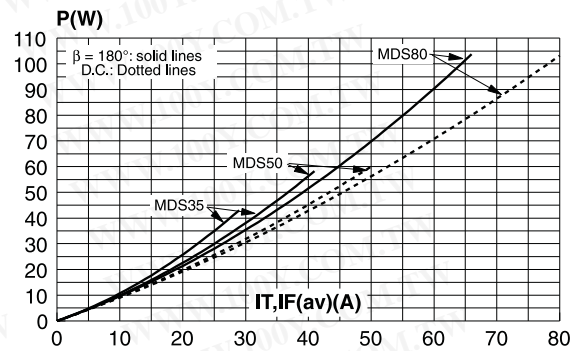


Fig. 1-3: Maximum total power dissipation versus output current on resistive or inductive load (Single phase bridge rectifier, two packages).

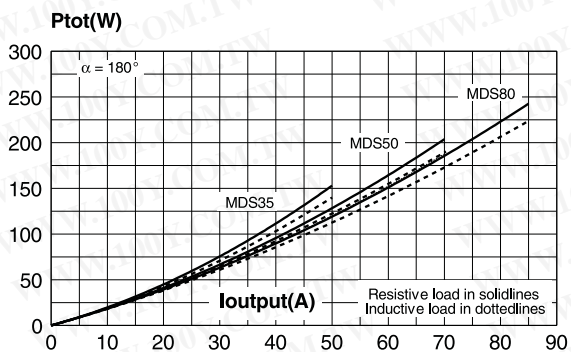


Fig. 1-4: Maximum total power dissipation versus output current (Three phase bridge rectifier, three packages).

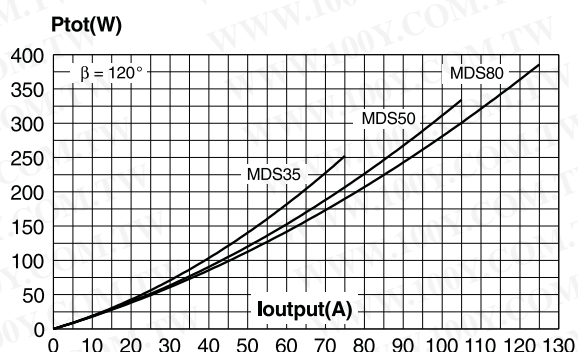


Fig. 2-1: Average on-state current versus case temperature (thyristor or diode, sinusoidal waveform).

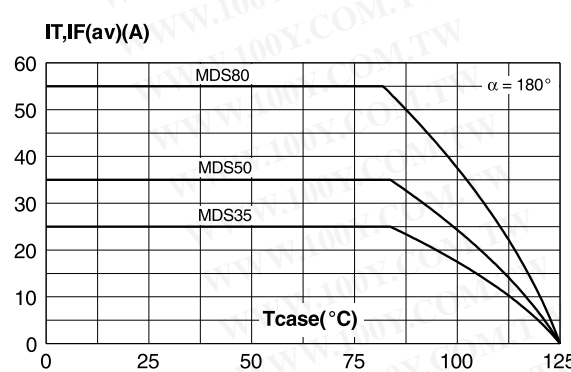
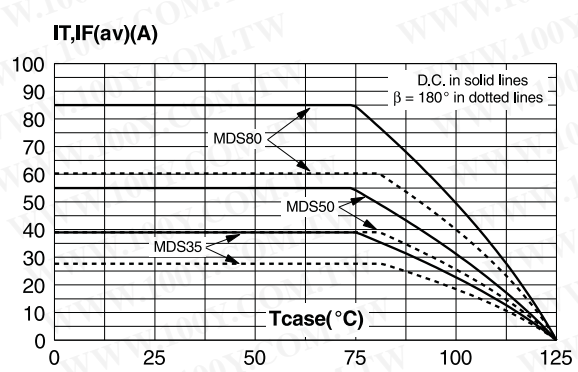


Fig. 2-2: Average on-state current versus case temperature (thyristor or diode, rectangular waveform).



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Fig. 3: Relative variation of thermal impedance junction to case versus pulse duration.

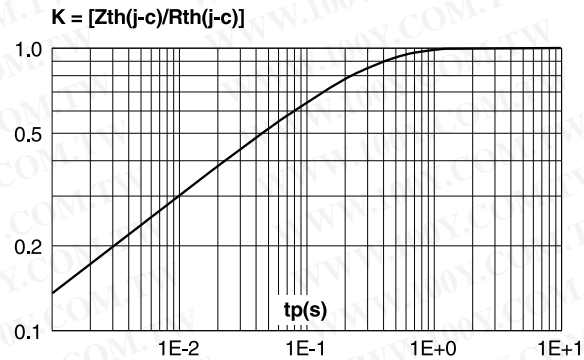


Fig. 5-1: Surge peak on-state current versus number of cycles (MDS35 and MDS50).

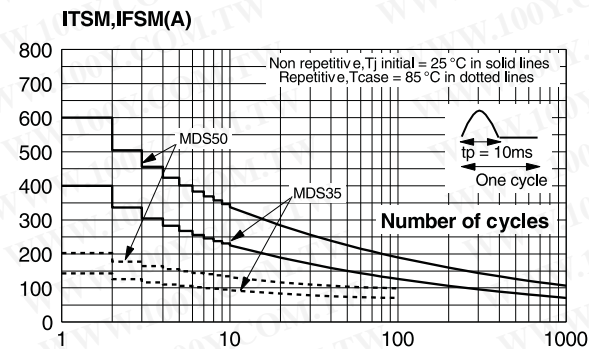


Fig. 6-1: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms, and corresponding value of I^2t (MDS35 and MDS50).

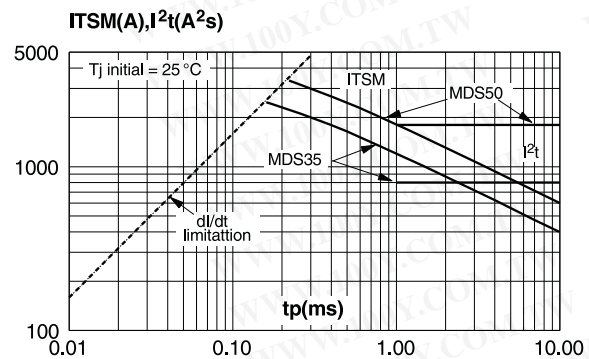


Fig. 4: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values).

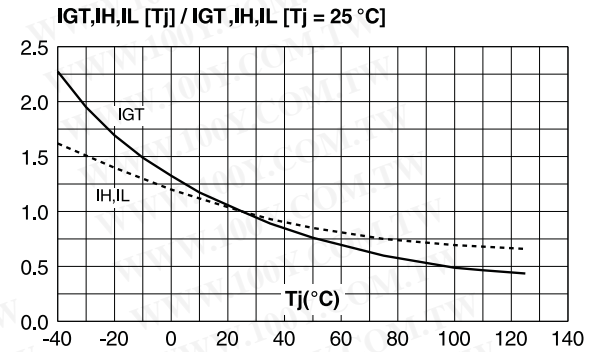


Fig. 5-2: Surge peak on-state current versus number of cycles (MDS80).

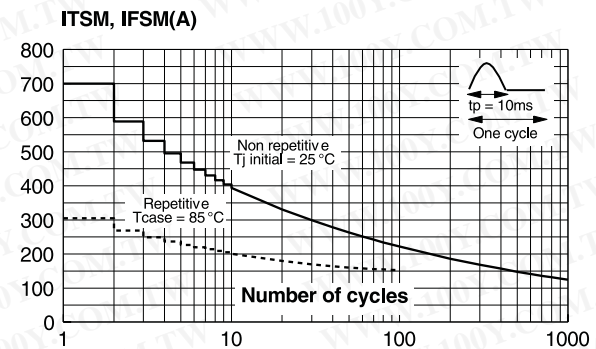
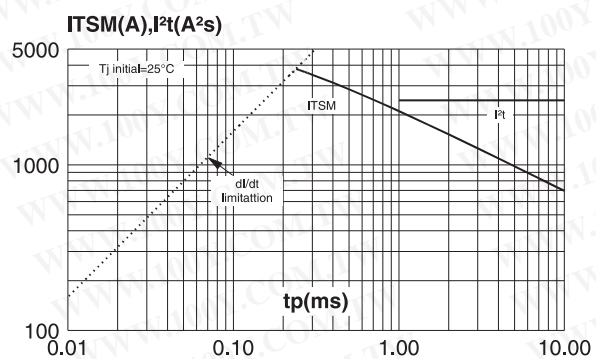


Fig. 6-2: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms, and corresponding value of I^2t (MDS80).



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Fig. 7-1: On-state characteristics (thyristor or diode, maximum values) (MDS35).

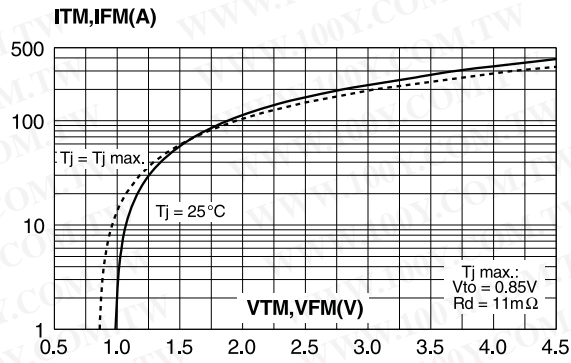


Fig. 7-2: On-state characteristics (thyristor or diode, maximum values) (MDS50).

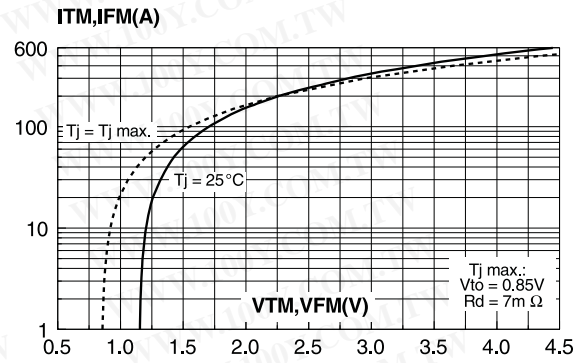
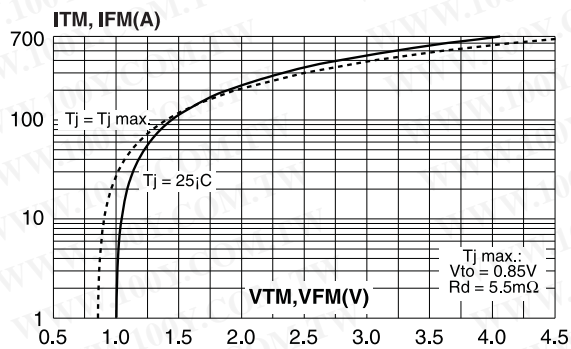


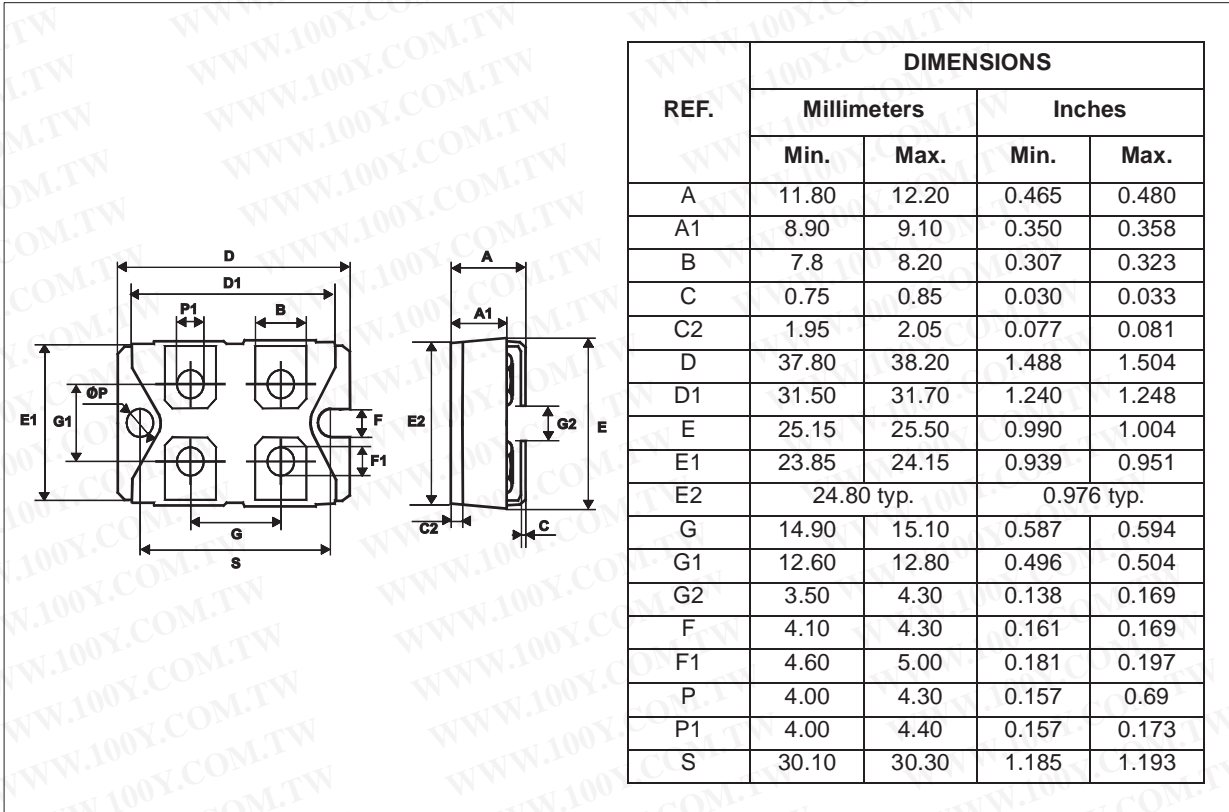
Fig. 7-3: On-state characteristics (thyristor or diode, maximum values) (MDS80).



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PACKAGE MECHANICAL DATA

ISOTOP™



- Recommended torque value: 1.3 Nm (max. 1.5 Nm) for the 6 x M4 screws (2 x M4 screws recommended for mounting the package on the heatsink and the 4 provided screws).
- The screws supplied with the package are adapted for mounting on a board (or other types of terminals) with a thickness of 0.6 mm min. and 2.2 mm max.

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